

Please add claims 24-32.

Sub D. 24. (New) An optoelectronic component carrier comprising a substrate, an optoelectronic component and a label, wherein said component and said label are mounted on said substrate, and said label comprises a coded data symbol having a two dimensional array of cells.

25. (New) An optoelectronic component carrier as claimed in claim 24 wherein the substrate and the label are integrally formed.

C\ 26. (New) An optoelectronic component carrier as claimed in claim 24 wherein the label further comprises a second substrate, said second substrate having an etchable layer into which the coded data symbol is etched.

27. (New) An optoelectronic device comprising an optoelectronic component carrier as claimed in claim 24.

28. (New) A method of labelling an optoelectronic component carrier comprising mounting on a substrate a label wherein said label comprises a coded data symbol having a two dimensional array of cells.

29. (New) A method of labelling an optoelectronic component carrier as claimed in claim 28 wherein said label is produced by providing a second substrate, providing an etchable layer on the second substrate and etching the etchable layer.

30. (New) A method of labelling an optoelectronic component carrier as claimed in claim 29 wherein the etching is performed using an electron beam technique.

31. (New) A vision system for reading a coded data symbol on an optoelectronic component carrier, wherein said symbol comprises a two dimensional array of cells, said vision system comprising a light source to illuminate the symbol and a detector capable of detecting a two dimensional pattern of light reflected from the symbol.

32. (New) An optoelectronic component carrier labeling system comprising a label carrying a coded identifier symbol for attachment to an optoelectronic component carrier, wherein the coded identifier symbol comprises a two dimensional array of cells, a vision system for reading and decoding the label and data storage means for storing at a location identifiable according to the decoded identifier data relevant to the component.

21
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Remarks

The Examiner rejects claims 1-23 under 35 U.S.C. § 102/103 as being "notoriously old". Claims 1-23 have been deleted without prejudice.

Claims 24-32 have been added and more clearly define the invention. Basis for these claims can be found in the specification and drawings as a whole. Specifically, basis can be found on page 7, line 12 which refers to "an optoelectronics component carrier" which is shown in figure 1 comprising a substrate (fig. 1, item 4), a component (fig. 1, item 8) and a label (fig. 1, item 10). Additional basis for claim 26 can be found on page 8, lines 4-11.